

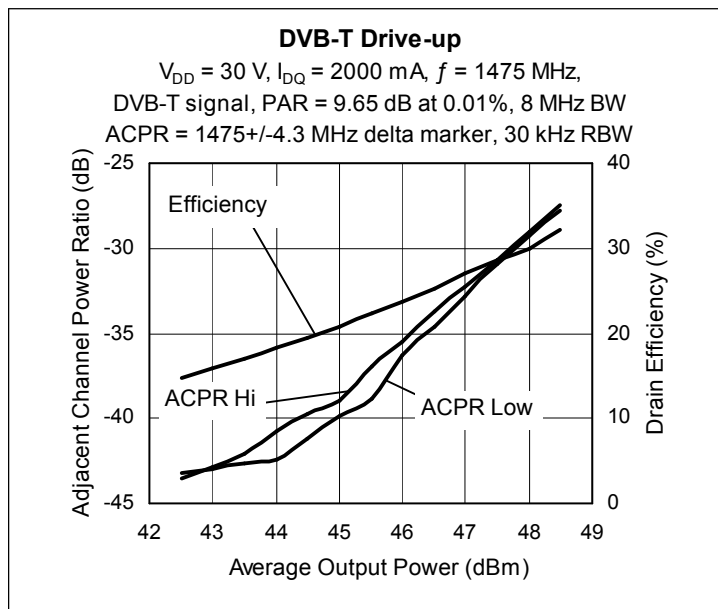
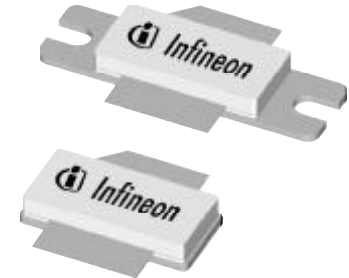
## Thermally-Enhanced High Power RF LDMOS FET 240 W, 1450 – 1500 MHz

### Description

The PTFA142401EL and PTFA142401FL are 240-watt LDMOS FETs designed for DVB and DAB applications in the 1450 to 1500 MHz frequency band. Features include internal I/O matching and thermally-enhanced packages with slotted or earless flanges. Manufactured with Infineon's advanced LDMOS process, these devices provide excellent thermal performance and superior reliability.

PTFA142401EL  
 Package H-33288-2

PTFA142401FL  
 Package H-34288-2



### Features

- Pb-free, RoHS-compliant and thermally-enhanced packages with less than 0.25 micron Au plating
- Broadband internal matching
- Typical DVB-T performance at 1475 MHz, 30 V
  - Average output power = 47.0 dBm
  - Linear Gain = 16.0 dB
  - Efficiency = 27.5%
  - Adjacent channel power = -32 dBc
- Typical CW performance, 1475 MHz, 30 V
  - Output power at P-1dB = 240 W
  - Efficiency = 52%
- Integrated ESD protection: Human Body Model, Class 2 (minimum)
- Excellent thermal stability, low HCI drift
- Capable of handling 10:1 VSWR @ 30 V, 200 W (CW) output power

### RF Characteristics

**DVB-T Measurements** (not subject to production test—verified by design/characterization in Infineon test fixture)

$V_{DD} = 30\text{ V}$ ,  $I_{DQ} = 2.0\text{ A}$ ,  $P_{OUT} = 50\text{ W}$  average

$f = 1475\text{ MHz}$  DVB-T, channel bandwidth = 8.0 MHz, peak/average = 9.65 dB @ 0.01% CCDF

Characteristic	Symbol	Min	Typ	Max	Unit
Gain	$G_{ps}$	—	16.5	—	dB
Drain Efficiency	$\eta_D$	—	27.5	—	%
Adjacent Channel Power Ratio ( $\pm 4.3\text{ MHz}$ offset, 30 kHz RBW)	ACPR	—	-32	—	dBc

All published data at  $T_{CASE} = 25^\circ\text{C}$  unless otherwise indicated

**ESD:** Electrostatic discharge sensitive device—observe handling precautions!

## RF Characteristics (cont.)

### Two-tone Measurements (tested in Infineon test fixture)

$V_{DD} = 30\text{ V}$ ,  $I_{DQ} = 2.0\text{ A}$ ,  $P_{OUT} = 240\text{ W PEP}$ ,  $f = 1500\text{ MHz}$ , tone spacing = 1 MHz

Characteristic	Symbol	Min	Typ	Max	Unit
Gain	$G_{ps}$	15.0	16.0	—	dB
Drain Efficiency	$\eta_D$	40	43	—	%
Intermodulation Distortion	IMD	—	-31	-29	dBc

## DC Characteristics

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}$ , $I_{DS} = 10\text{ mA}$	$V_{(BR)DSS}$	65	—	—	V
Drain Leakage Current	$V_{DS} = 28\text{ V}$ , $V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	1.0	$\mu\text{A}$
Drain Leakage Current	$V_{DS} = 63\text{ V}$ , $V_{GS} = 0\text{ V}$	$I_{DSS}$	—	—	10.0	$\mu\text{A}$
On-State Resistance	$V_{GS} = 10\text{ V}$ , $V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	0.05	—	$\Omega$
Operating Gate Voltage	$V_{DS} = 30\text{ V}$ , $I_{DQ} = 2.0\text{ A}$	$V_{GS}$	2.0	2.5	3.0	V
Gate Leakage Current	$V_{GS} = 10\text{ V}$ , $V_{DS} = 0\text{ V}$	$I_{GSS}$	—	—	1.0	$\mu\text{A}$

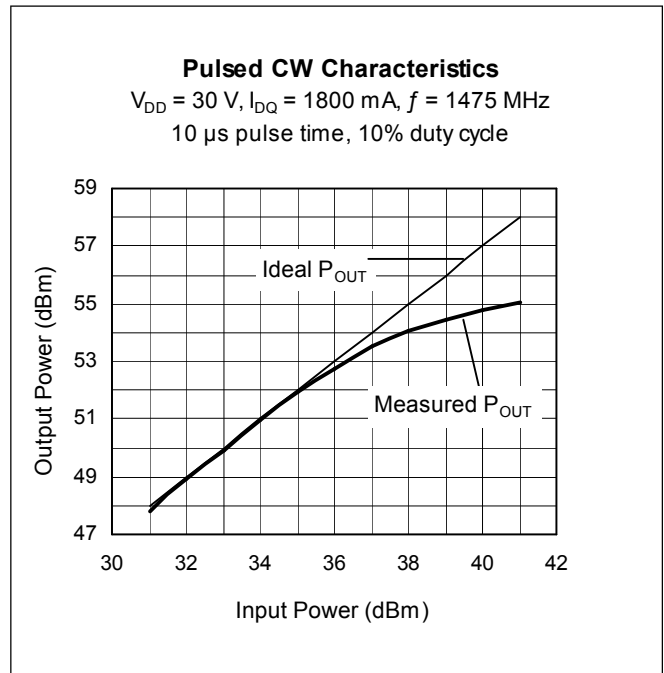
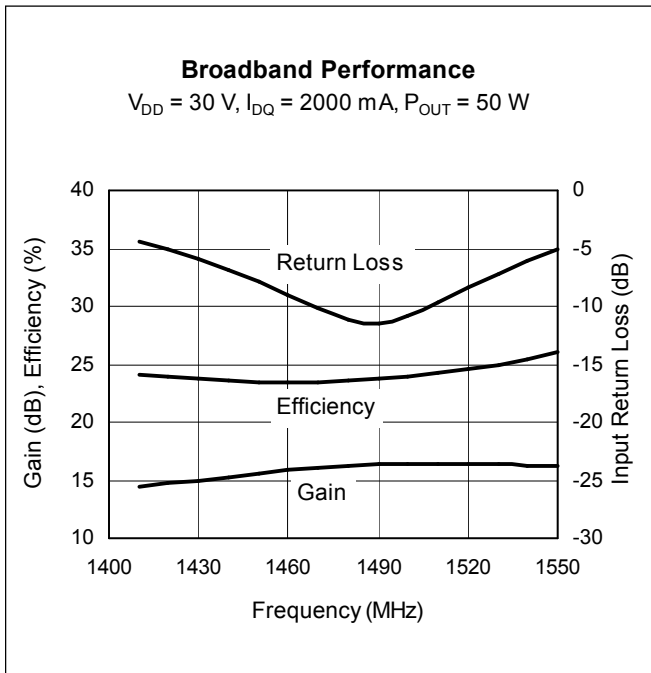
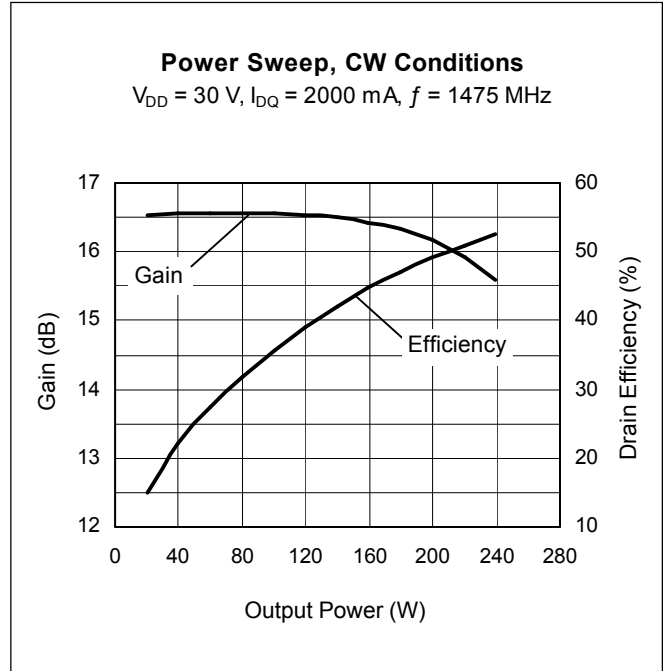
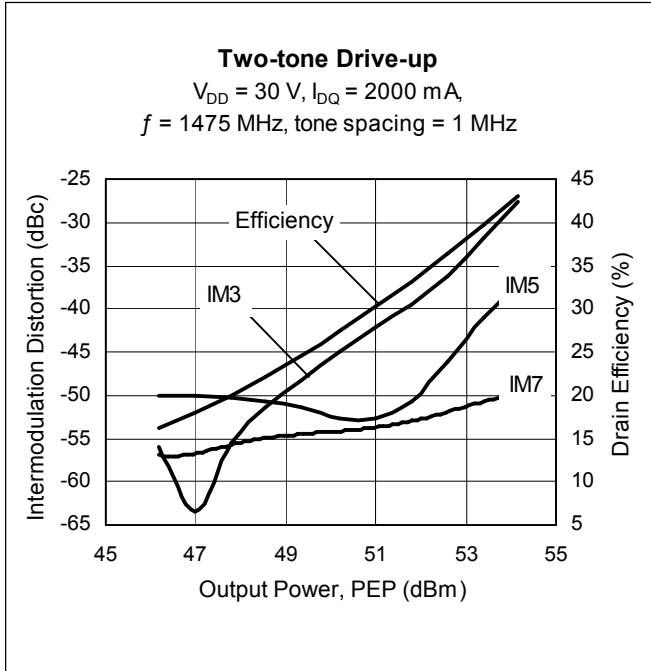
## Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	V
Gate-Source Voltage	$V_{GS}$	-0.5 to +12	V
Junction Temperature	$T_J$	200	$^{\circ}\text{C}$
Total Device Dissipation Above 25 $^{\circ}\text{C}$ derate by	$P_D$	625 3.57	W W/ $^{\circ}\text{C}$
Storage Temperature Range	$T_{STG}$	-40 to +150	$^{\circ}\text{C}$
Thermal Resistance ( $T_{CASE} = 70^{\circ}\text{C}$ , 240 W CW)	$R_{\theta JC}$	0.28	$^{\circ}\text{C}/\text{W}$

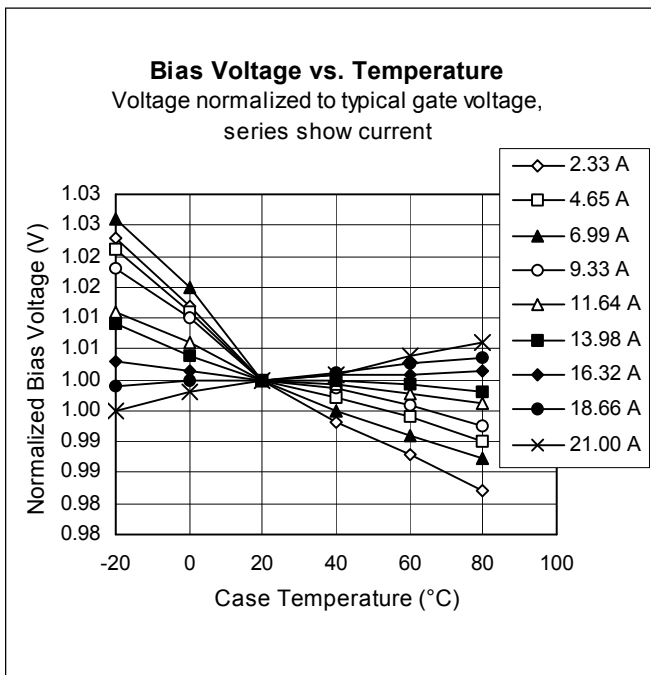
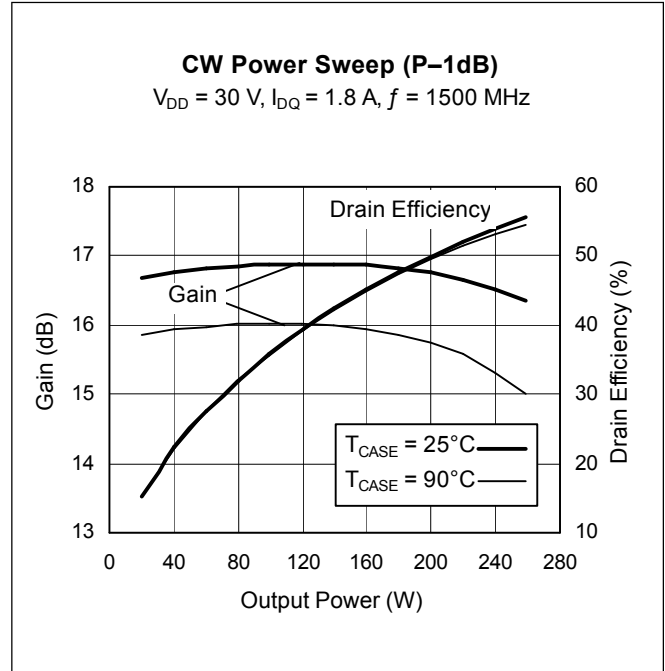
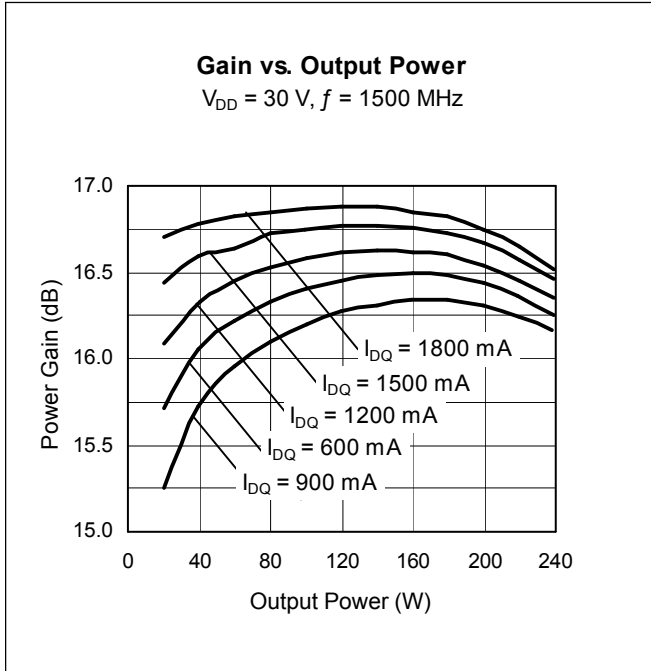
## Ordering Information

Type and Version	Package Outline	Package Description	Shipping	Marking
PTFA142401EL V4	H-33288-2	Thermally-enhanced, slotted flange, single-ended	Tray	PTFA142401EL
PTFA142401FL V4	H-34288-2	Thermally-enhanced, earless flange, single-ended	Tray	PTFA142401FL

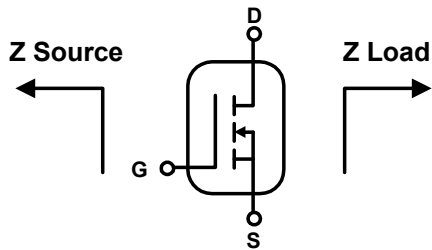
**Typical Performance** (data taken in an Infineon test fixture)



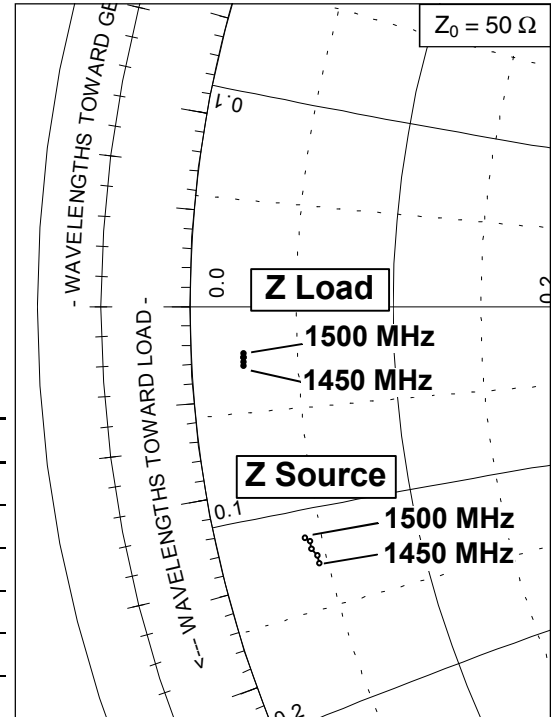
Typical Performance (cont.)



### Broadband Circuit Impedance

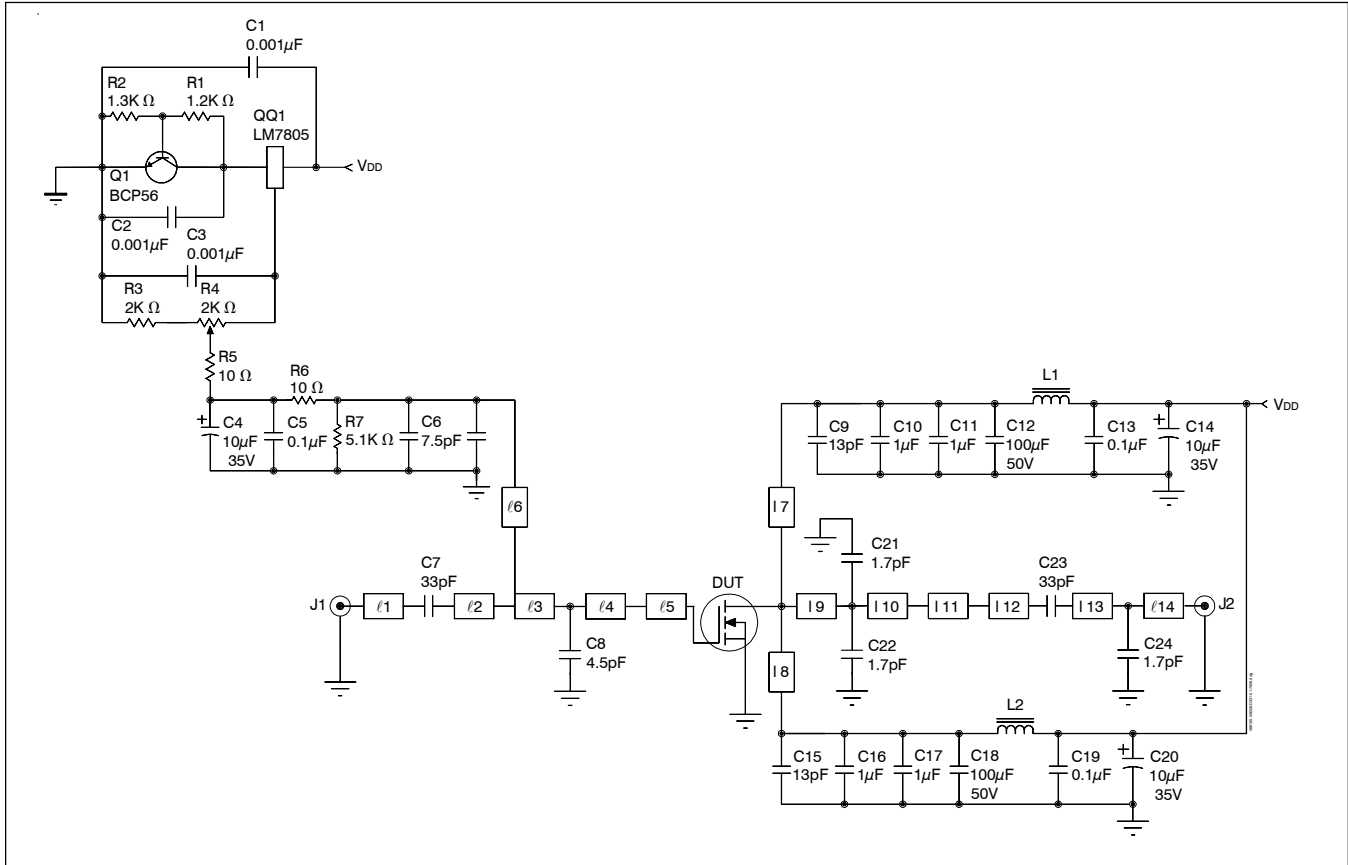


Frequency	Z Source W		Z Load W	
	R	jX	R	jX
1450	2.3	-6.4	1.2	-1.4
1463	2.3	-6.2	1.2	-1.3
1475	2.2	-6.0	1.2	-1.2
1488	2.2	-5.8	1.2	-1.2
1500	2.1	-5.7	1.2	-1.1



See next page for circuit information

### Reference Circuit



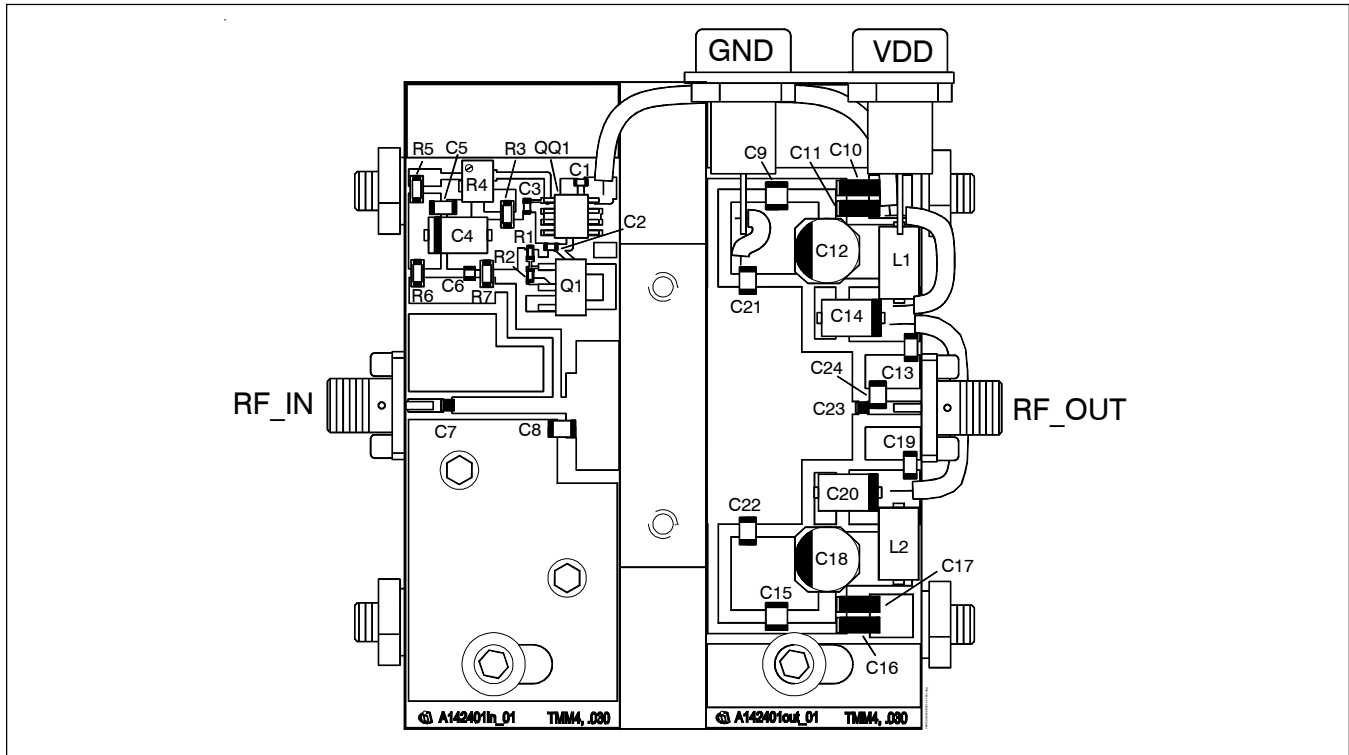
Reference circuit schematic for  $f = 1475 \text{ MHz}$

#### Circuit Assembly Information

DUT	PTFA142401EL or PTFA142401FL	LDMOS Transistor	
PCB	0.76 mm [.030"] thick, $\epsilon_r = 4.5$	TMM4	2 oz. copper

Microstrip	Electrical Characteristics at 1475 MHz	Dimensions: L x W ( mm )	Dimensions: L x W ( in. )
$\ell_1$	$0.038 \lambda$ , 53.1, $\Omega$	4.17 x 1.52	0.164 x 0.060
$\ell_2$	$0.108 \lambda$ , 47.5, $\Omega$	11.86 x 1.91	0.467 x 0.075
$\ell_3$	$0.014 \lambda$ , 47.5, $\Omega$	1.57 x 1.91	0.062 x 0.075
$\ell_4$	$0.012 \lambda$ , 16.3, $\Omega$	1.22 x 7.62	0.048 x 0.300
$\ell_5$	$0.051 \lambda$ , 8.9, $\Omega$	5.08 x 15.24	0.200 x 0.600
$\ell_6$	$0.171 \lambda$ , 66.9, $\Omega$	19.10 x 1.02	0.752 x 0.040
$\ell_7, \ell_8$	$0.177 \lambda$ , 60.0, $\Omega$	19.66 x 1.27	0.774 x 0.050
$\ell_9$	$0.049 \lambda$ , 5.0, $\Omega$	4.80 x 27.94	0.189 x 1.100
$\ell_{10}$	$0.065 \lambda$ , 5.0, $\Omega$	6.38 x 27.94	0.251 x 1.100
$\ell_{11}$	$0.059 \lambda$ , 10.6, $\Omega$	5.97 x 12.70	0.235 x 0.500
$\ell_{12}$	$0.006 \lambda$ , 53.1, $\Omega$	0.71 x 1.52	0.028 x 0.060
$\ell_{13}$	$0.011 \lambda$ , 53.1, $\Omega$	1.19 x 1.52	0.047 x 0.060
$\ell_{14}$	$0.046 \lambda$ , 53.1, $\Omega$	5.05 x 1.52	0.199 x 0.060

Reference Circuit (cont.)

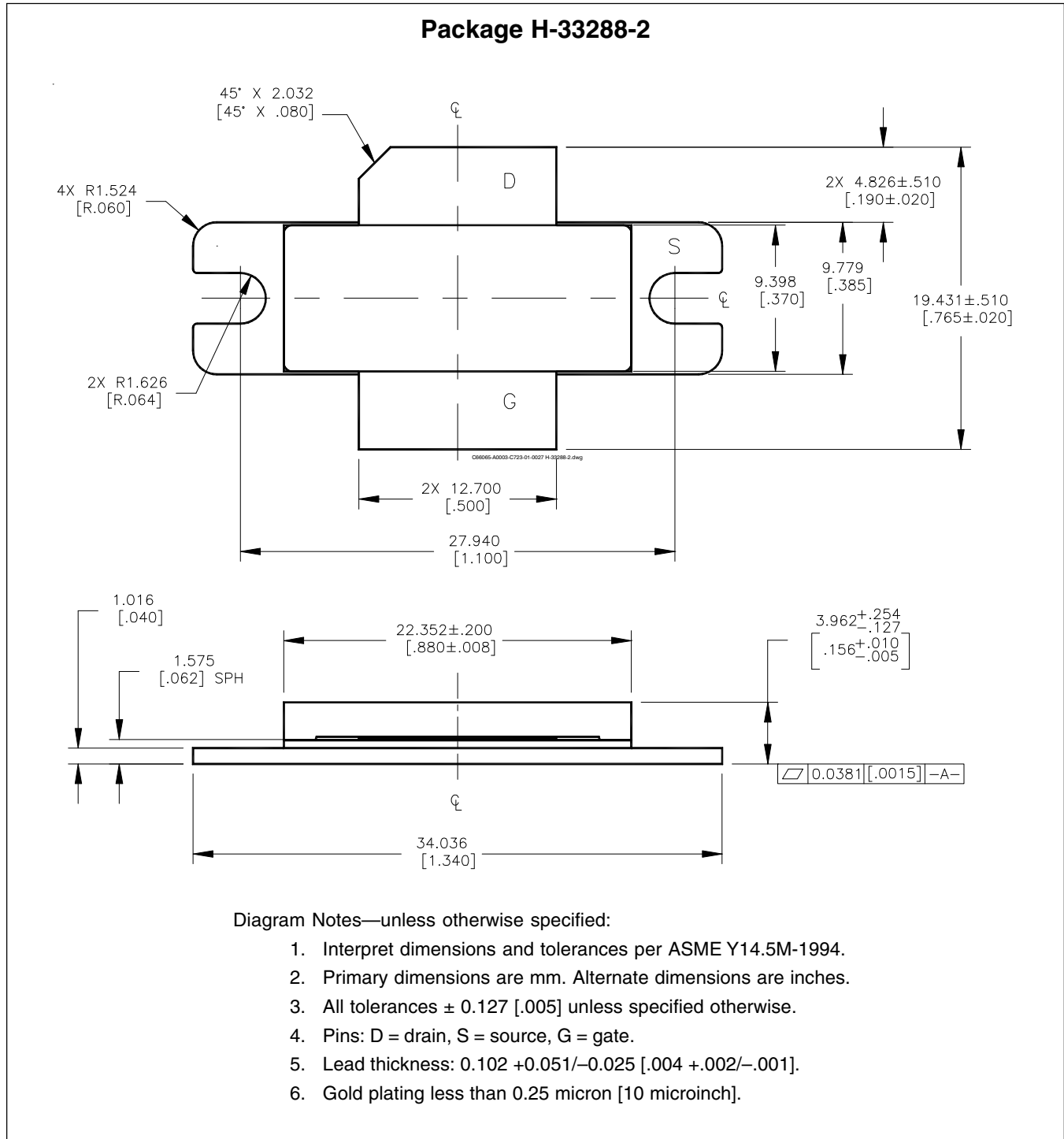


Reference circuit assembly diagram \* (not to scale)

Component	Description	Suggested Manufacturer	P/N or Comment
C1, C2, C3	Capacitor, 0.001 $\mu$ F	Digi-Key	PCC1772CT-ND
C4, C14, C20	Tantalum capacitor, 10 $\mu$ F, 35 V	Digi-Key	399-1655-2-ND
C5, C13, C19	Capacitor, 0.1 $\mu$ F	Digi-Key	PCC104BCT-ND
C6	Ceramic capacitor, 7.5 pF	ATC	100B 7R5
C7, C23	Ceramic capacitor, 33 pF	ATC	100B 330
C8	Ceramic capacitor, 4.5 pF	ATC	100B 4R5
C9, C15	Ceramic capacitor, 13 pF	ATC	100B 130
C10, C11, C16, C17	Capacitor, 1 $\mu$ F	ATC	920C105
C12, C18	Electrolytic capacitor, 100 $\mu$ F, 50 V	Digi-Key	PCE3718CT-ND
C21, C22, C24	Ceramic capacitor, 1.7 pF	ATC	100B 1R7
L1, L2	Ferrite, 8.9 mm	Elna Magnetics	BDS 4.6/3/8.9-4S2
Q1	Transistor	Infineon Technologies	BCP56
QQ1	Voltage regulator	National Semiconductor	LM7805
R1	Chip resistor, 1.2k ohms	Digi-Key	P1.2KGCT-ND
R2	Chip resistor, 1.3k ohms	Digi-Key	P1.3KGCT-ND
R3	Chip resistor, 2k ohms	Digi-Key	P2KECT-ND
R4	Potentiometer, 2k ohms	Digi-Key	3224W-202ETR-ND
R5, R7	Chip resistor, 5.1k ohms	Digi-Key	P5.1KECT-ND
R6	Chip resistor, 10 ohms	Digi-Key	P10ECT-ND

\*Gerber Files for this circuit available on request

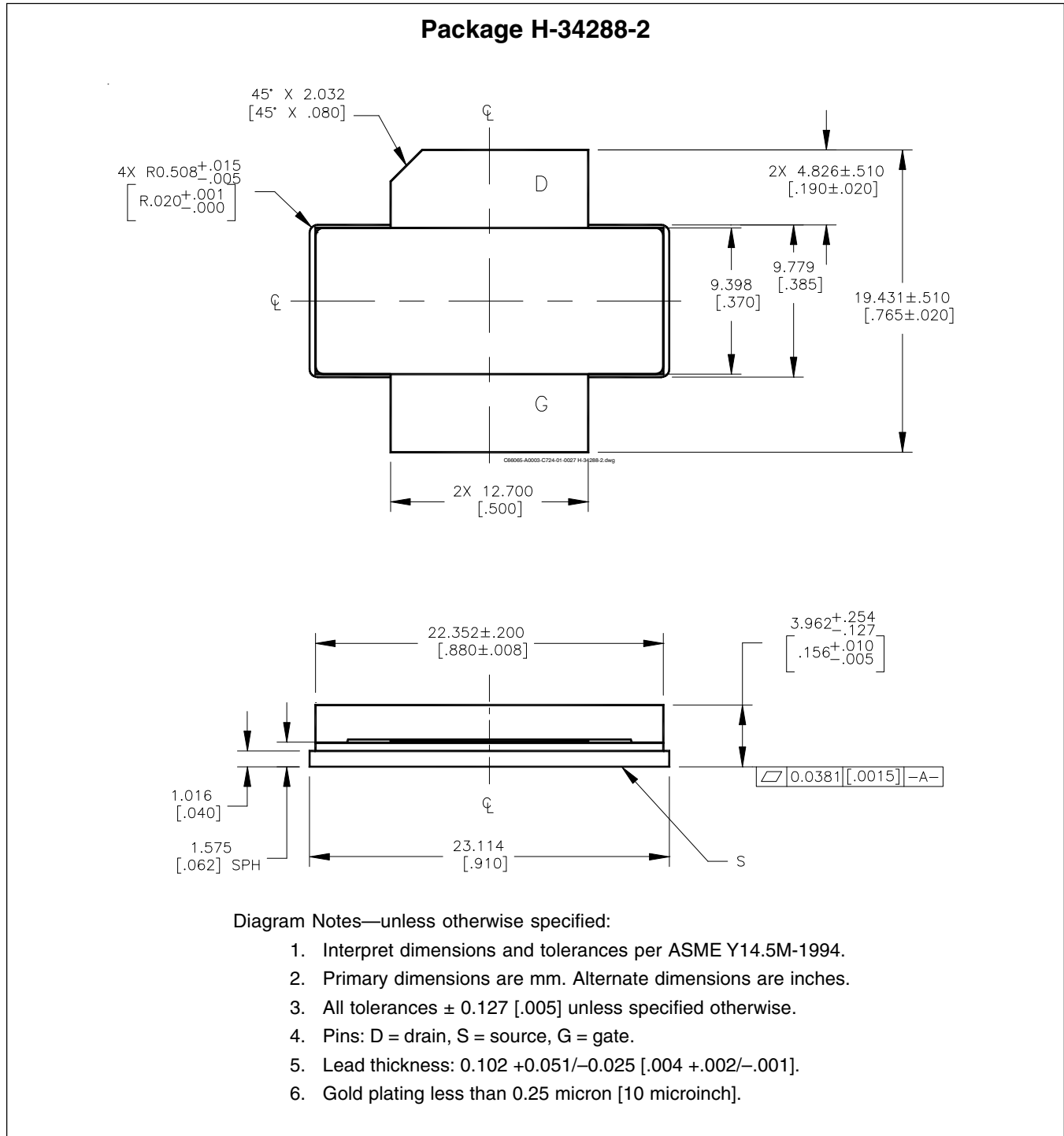
## Package Outline Specifications



Find the latest and most complete information about products and packaging at the Infineon Internet page <http://www.infineon.com/rfpower>



Package Outline Specifications (cont.)



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Previous Version: 2009-03-31, Data Sheet

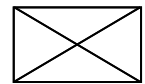
Page	Subjects (major changes since last revision)
6, 7	Fixed typing error

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